

CHIC 2015

CHINA HARDWARE INNOVATION CAMP

Ever thought of being a tech innovator?

Do you want to work in a multidisciplinary team,
design a new device, test its business strategy
and manufacture it in Greater China?

Are you ready to take your
semester project to another level?



The China Hardware Innovation Camp (CHIC) will allow you to discover one of the most dynamic hubs for hardware innovation.

In the framework of your semester project you will go from idea to production in less than 30 working days. Your team will engage in sourcing, assembly, prototyping and manufacturing a connected hardware device. During the semester you will have to interact with local capabilities to make your project a success.

In addition you will have the opportunity to understand the Hong Kong/Shenzhen eco-system by visiting some leading organizations (Huawei, Foxconn, Hong Kong Science & Technology Park, etc.)

Timeline

December 19 2015:	Registration
February 14-15 2015:	Kick-off week-end
Spring semester 2015:	On campus work (1 day/per week)
Mid-July 2015:	Fly to Hong Kong and Shenzhen to manufacture your device
September 2015:	Demo day at EPFL

Register via the QR CODE and embark on an “accelerated innovation” journey!



Co-organized with



With the support of

